

April 2013

FQP50N06L N-Channel QFET® MOSFET 60 V, 52.4 A, 21 mΩ

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor®'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 52.4 A, 60 V, $R_{DS(on)}$ = 21 m Ω (Max.) @ V_{GS} = 10 V, I_D = 26.2 A
- Low Gate Charge (Typ. 24.5 nC)
- Low Crss (Typ. 90 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQP50N06L	Unit
V _{DSS}	Drain-Source Voltage		60	V
I _D	Drain Current - Continuous (T _C = 25°	C)	52.4	А
	- Continuous (T _C = 100°C)		37.1	А
I _{DM}	Drain Current - Pulsed	(Note 1)	210	А
V _{GSS}	Gate-Source Voltage		± 20	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	990	mJ
I _{AR}	Avalanche Current	(Note 1)	52.4	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	12.1	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	7.0	V/ns
P_D	Power Dissipation (T _C = 25°C)		121	W
	- Derate above 25°C		0.81	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
T _L	Maximum lead temperature for soldering purposes,		300	°C

Thermal Characteristics

Symbol	Parameter	FQP50N06L	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	1.24	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
ΔBV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.06		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 60 V, V _{GS} = 0 V			1	μΑ
		V _{DS} = 48 V, T _C = 150°C			10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	1.0		2.5	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_D = 26.2 \text{ A}$ $V_{GS} = 5 \text{ V}, I_D = 26.2 \text{ A}$		0.017 0.020	0.021 0.025	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 25 V, I _D = 26.2 A (Note 4)		40		S
C _{oss} C _{rss}	Output Capacitance Reverse Transfer Capacitance	f = 1.0 MHz		445 90	580 120	pF pF
C _{rss}	Reverse Transfer Capacitance	1 = 1.0 WHZ		90	120	pF
Switchi	ng Characteristics					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 30 \text{ V}, I_{D} = 26.2 \text{ A},$		20	50	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$		380	770	ns
t _{d(off)}	Turn-Off Delay Time	3		80	170	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		145	300	ns
Qg	Total Gate Charge	V _{DS} = 48 V, I _D = 52.4 A,		24.5	32	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 5 V		6		nC
	Gate-Drain Charge	(Note 4, 5)		14.5		nC
Q _{gd} Drain-S	Gate-Drain Charge ource Diode Characteristics ar	(Note 4, 5)		-		n
l _S	Maximum Continuous Drain-Source Diode Forward Current				52.4	Α
I _{SM}	Maximum Pulsed Drain-Source Diode F				210	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 52.4 \text{ A}$			1.5	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_S = 52.4 \text{ A},$		65		ns
Q_{rr}		$dI_F / dt = 100 A/\mu s$ (Note 4)				

- Notes: Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature 2. L = 300µH, $I_{AS} = 52.4A$, $V_{DD} = 25V$, $R_{G} = 25\,\Omega$, Starting $T_{J} = 25^{\circ}C$ 3. $I_{SD} \leq 52.4A$, di/dt $\leq 300A/\mu$ s, $V_{DD} \leq BV_{DSS}$, Starting $T_{J} = 25^{\circ}C$ 4. Pulse 7est: Pulse width $\leq 300\mu$ s, Duty cycle $\leq 2\%$ 5. Essentially independent of operating temperature

Typical Characteristics

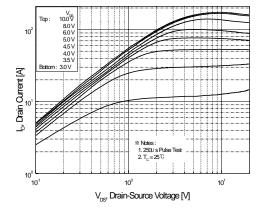


Figure 1. On-Region Characteristics

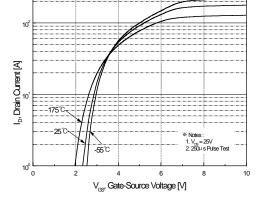


Figure 2. Transfer Characteristics

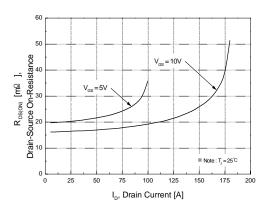


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

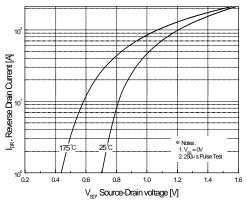


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

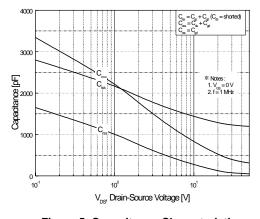


Figure 5. Capacitance Characteristics

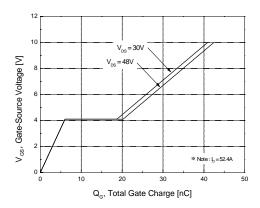
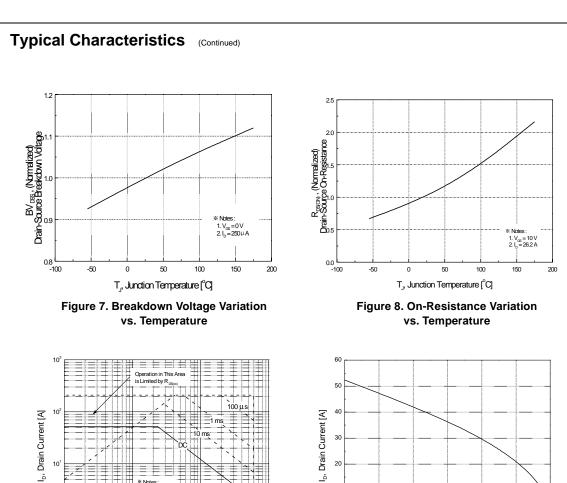


Figure 6. Gate Charge Characteristics





 V_{DS} , Drain-Source Voltage [V]

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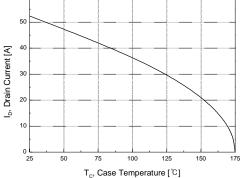
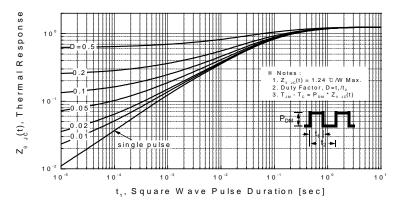


Figure 10. Maximum Drain Current vs. Case Temperature

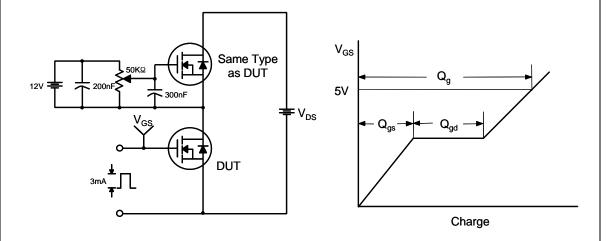


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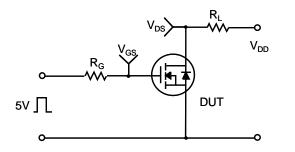
Figure 11. Transient Thermal Response Curve

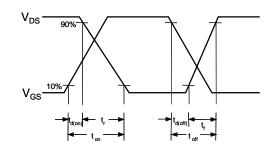
10⁻¹

Gate Charge Test Circuit & Waveform

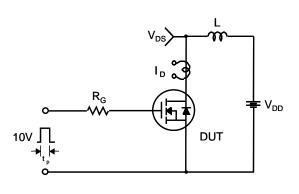


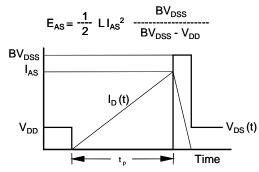
Resistive Switching Test Circuit & Waveforms



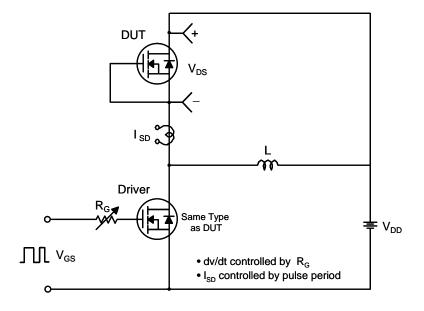


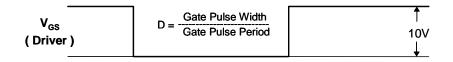
Unclamped Inductive Switching Test Circuit & Waveforms

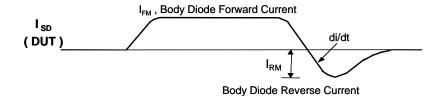


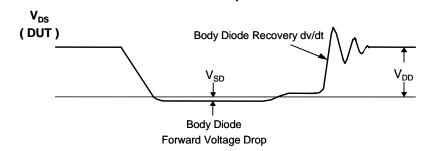


Peak Diode Recovery dv/dt Test Circuit & Waveforms



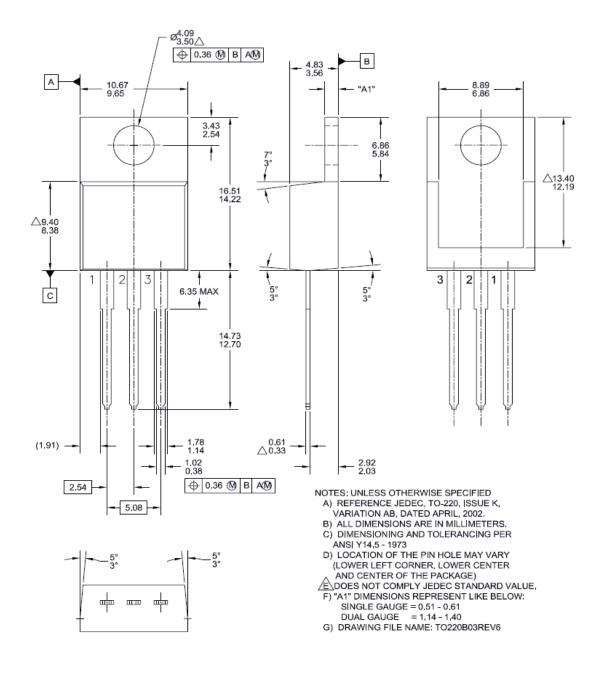






Mechanical Dimensions

TO-220B03







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